ABSOLUTE MAXIMUM RATINGS

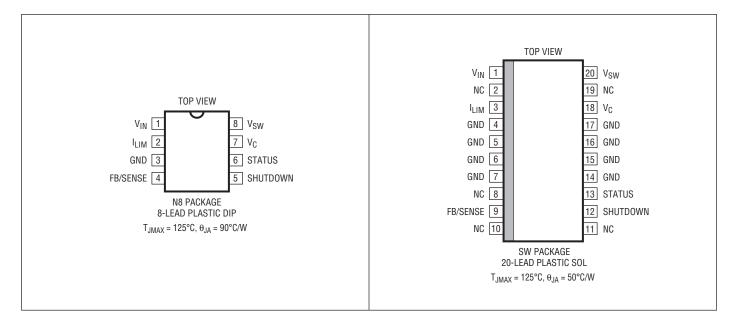
(Note 1)

Input Voltage38	V
Switch Voltage with Respect to Input Voltage50	
Switch Voltage with Respect to Ground Pin	
(V _{SW} Negative) (Note 7)20	V
Feedback Pin Voltage2V, 10	V
Shutdown Pin Voltage (Not to Exceed V _{IN})35	V
Status Pin Voltage	
(Current Must Be Limited to 5mA When Status Pin	
Switches ON)	V

I _{LIM} Pin Voltage (Forced)5.5V
Maximum Operating Ambient Temperature Range
LT1176C/LT1176C-50°C to 70°C
Maximum Operating Junction Temperature Range
LT1176C/LT1176C-50°C to 125°C
Storage Temperature Range65°C to 150°C
Lead Temperature (Soldering, 10 sec)300°C

^{*}These thermal resistance numbers are for typical mounting technique. Lower thermal resistance can be obtained with large copper lands, thermal glues or heat sinks.

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT1176CN8#PBF		LT1176CN8	8-Lead Plastic DIP	0°C to 125°C
LT1176CN8-5#PBF		LT1176CN8-5	8-Lead Plastic DIP	0°C to 125°C
LT1176CSW#PBF	LT1176CSW#TRPBF	LT1176CSW	20-Lead Plastic SOL	0°C to 125°C
LT1176CSW-5#PBF	LT1176CSW-5#TRPBF	LT1176CSW-5	20-Lead Plastic SOL	0°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/ For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

LINEAR

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25\,^{\circ}\text{C}$. $T_J = 25\,^{\circ}\text{C}$, V_{IN} 25V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Switch ON Voltage (Note 2)	I _{SW} = 0.2A I _{SW} = 1A	•			1.1 1.4	V
Switch OFF Leakage	$V_{IN} = 25V, V_{SW} = 0$ $V_{IN} = V_{MAX}, V_{SW} = 0$ (Note 8)				150 250	μA μA
Supply Current (Note 3)	V_{FB} = 2.5V, V_{IN} \leq 35V V_{SHDN} = 0.1V (Device Shutdown) (Note 9)	•		7.5 140.0	10 300	mA μA
Minimum Supply Voltage	Normal Mode Startup Mode (Note 4)	•		7.3 3.5	8.0 4.8	V
Switch Current Limit (Note 5)	I _{LIM} Open R _{LIM} = 10k (Note 6) R _{LIM} = 7k (Note 6)	•	1.2	1.7 1.2 0.8	2.2	A A A
Maximum Duty Cycle		•	85	90		%
Switching Frequency	V _{FB} = 0V Through 2k (Note 5) (LT1176) V _{SENSE} = 0V (Note 5) (LT1176-5)	•	90 85	100 20 20	110 120	kHz kHz kHz kHz
Switching Frequency Line Regulation	$8V \le V_{IN} \le V_{MAX}$ (Note 8)	•		0.03	0.1	%/V
Error Amplifier Voltage Gain (Note 10)	$1V \le V_{\mathbb{C}} \le 4V$			2000		V/V
Error Amplifier Transconductance (Note 10)			3700	5000	8000	μmho
Error Amplifier Source and Sink Current	Source ($V_{FB} = 2V$ or $V_{SENSE} = 4V$) Sink ($V_{FB} = 2.5V$ or $V_{SENSE} = 5.5V$)		100.0 0.7	140 1.0	225.0 1.6	μA mA
Feedback Pin Bias Current (LT1176)	$V_{FB} = V_{REF}$	•		0.5	2	μА
Reference Voltage (LT1176)	V _C = 2V	•	2.155	2.21	2.265	V
Reference Voltage Tolerance (LT1176)	V _{REF} (Nominal) = 2.21V All Conditions of Input Voltage, Output Voltage, Temperature and Load Current	•		±0.5 ±1.0	±2 ±3	% %
Sense Voltage (LT1176-5)	V _C = 2V	•	4.85	5	5.15	V
Sense Voltage Tolerance (LT1176-5)	V _{OUT} (Nominal) = 5V All Conditions of Input Voltage, Temperature and Load Current	•		±0.5 ±0.1	±2 ±3	% %
Sense Pin Divider Resistance (LT1176-5)			3	5	8	kΩ
Output Voltage Line Regulation	$8V \le V_{IN} \le V_{MAX}$ (Note 8)	•		0.005	0.02	%/V
V _C Voltage at 0% Duty Cycle	Overtemperature	•		1.5 -4.0		V mV/°C
Multiplier Reference Voltage				24		V
Shutdown Pin Current	$V_{SHDN} = 5V$ $V_{SHDN} \le V_{THRESHOLD} (\cong 2.5V)$	•	5	10	20 50	μA μA
Shutdown Thresholds	Switch Duty Cycle = 0 Fully Shutdown	•	2.2 0.1	2.45 0.30	2.7 0.5	V V
Status Window	As a Percent of Output Voltage		±4	±5	±6	%
Status High Level	I _{STATUS} = 10μA Sourcing	•	3.5	4.5	5.0	V

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $T_J = 25^{\circ}C$, V_{IN} 25V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Status Low Level	I _{STATUS} = 1.6mA Sinking	•		0.25	0.4	V
Status Delay Time				9		μs
Status Minimum Width				30		μs

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: To calculate maximum switch ON voltage at current between low and high conditions, a linear interpolation may be used.

Note 3: A feedback pin voltage (V_{FB}) of 2.5V forces the V_{C} pin to its low clamp level and the switch duty cycle to zero. This approximates the zero load condition where duty cycle approaches zero. The LT1176-5 has $V_{SENSE} = 5.5V$.

Note 4: Total voltage from V_{IN} pin to ground pin must be \geq 8V after start-up for proper regulation.

Note 5: Switch frequency is internally scaled down when the feedback pin voltage is less than 1.3V to avoid extremely short switch-on times. During testing, V_{FB} or V_{SENSE} is adjusted to give a minimum switch-on time of 1us.

Note 6: $I_{LM} = (R_{LIM} - 1k)/7.65k$

Note 7: Switch to input voltage limitation must also be observed.

Note 8: $V_{MAX} = 35V$

Note 9: Does not include switch leakage.

Note 10: Error amplifier voltage gain and transconductance are specified relative to the internal feedback node. To calculate gain and transconductance from the sense pin (Output) to the V_{C} pin on the LT1176-5, multiply by 0.44.

Application Hints

Although the LT1176 has a peak switch rating of 1.2A and a maximum duty cycle of 85%, it must be used cautiously in applications which require high switch current and high duty cycle simultaneously, to avoid excessive chip temperature. Thermal resistance is 90°C/W for the 8-pin DIP package and 50°C/W for the 20-pin SO. This limits continuous chip power dissipation to the 0.5W to 1W range. These numbers assume typical mounting techniques. Extra or thick copper connected to the leads can reduce thermal resistance. Bonding the package to the board or using a clip style heat sink can also help. The following formulas will give chip power dissipation and peak switch current for the standard buck converter. Note that surges less than 30 seconds do not need to be considered from a thermal standpoint, but for proper regulation, they must not result in peak switch currents exceeding the 1.2A limit.

 $Power = I_{LOAD}(V_{OUT}/V_{IN}) + V_{IN} [7mA + 3mA (V_{OUT}/V_{IN}) + 0.012 (I_{LOAD})]$

 $I_{PEAK} = I_{LOAD(PEAK)} + [V_{OUT}(V_{IN} - V_{OUT})]/2E^{5}(V_{IN})(L)$

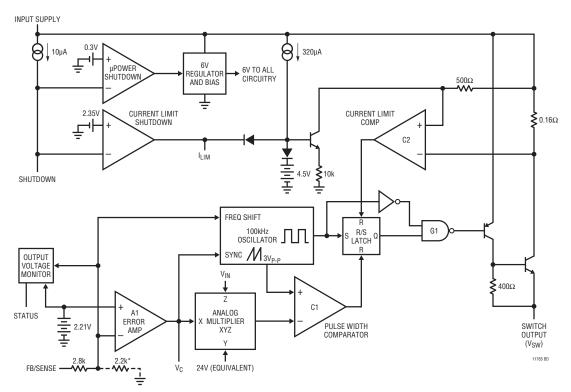
Example: V_{IN} = 15V, V_{OUT} = 5V, I_{LOAD} = 0.5A Continuous, 0.8A Peak, $L = 100 \mu H$

Power $(I_{LOAD} = 0.5A) = 0.38W$

 $I_{PEAK} (I_{LOAD} = 0.8A) = 0.97A$

Where component size or height is critical, we suggest using solid tantalum capacitors (singly or in parallel), but be sure to use units rated for switching applications. Coiltronics is a good source for low profile surface mount inductors and AVX makes high quality surface mount tantalum capacitors. For further help, use Application Notes 19 and 44,LTC's SwitcherCAD® computer design program, and our knowledgeable application department.

BLOCK DIAGRAM



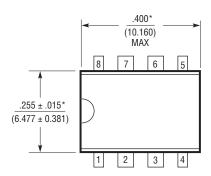
*CONNECTED ON 5V VERSION ONLY

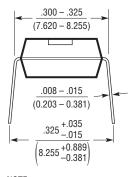
Downloaded from Arrow.com.

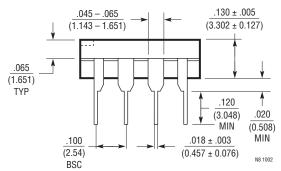
PACKAGE DESCRIPTION

N8 Package 8-Lead PDIP (Narrow .300 Inch)

(Reference LTC DWG # 05-08-1510)







NOTE:
1. DIMENSIONS ARE MILLIMETERS

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

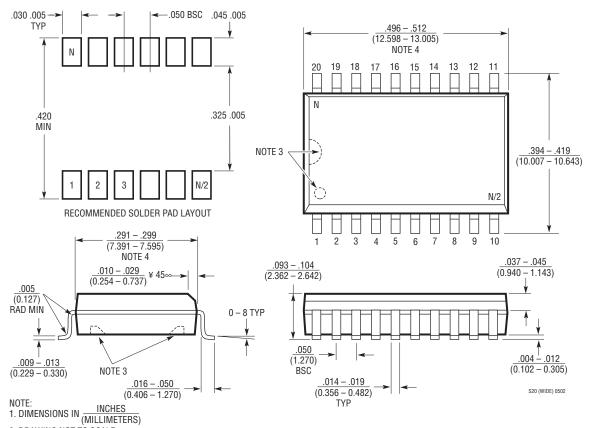
REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	01/11	Corrected Typical Application	1
		Updated part markings in Order Information	2
		Revised Electrical Characteristics	3
		Updated Package Description	8
В	2/11	Revised Shutdown Pin Current in Electrical Characteristics	3

PACKAGE DESCRIPTION

SW Package 20-Lead Plastic Small Outline (Wide .300 Inch)

(Reference LTC DWG # 05-08-1620)



- 2. DRAWING NOT TO SCALE
- 2. DIAWHOUT TO SOLE AND AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS
- 4. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)